



# 3.3V CMOS 16-BIT BUS TRANSCEIVER/REGISTER WITH 3-STATE OUTPUTS, 5 VOLT TOLERANT I/O AND BUS-HOLD

**IDT74LVCHR16646A**

## FEATURES:

- Typical  $t_{SK(O)}$  (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- 0.635mm pitch SSOP, 0.50mm pitch TSSOP and 0.40mm pitch TVSOP packages
- Extended commercial range of -40°C to +85°C
- $V_{CC} = 3.3V \pm 0.3V$ , Normal Range
- $V_{CC} = 2.7V$  to 3.6V, Extended Range
- CMOS power levels (0.4μW typ. static)
- All inputs, outputs and I/O are 5 Volt tolerant
- Supports hot insertion

### Drive Features for LVCHR16646A:

- Balanced Output Drivers: ±12mA
- Low switching noise

## APPLICATIONS:

- 5V and 3.3V mixed voltage systems
- Data communication and telecommunication systems

## DESCRIPTION:

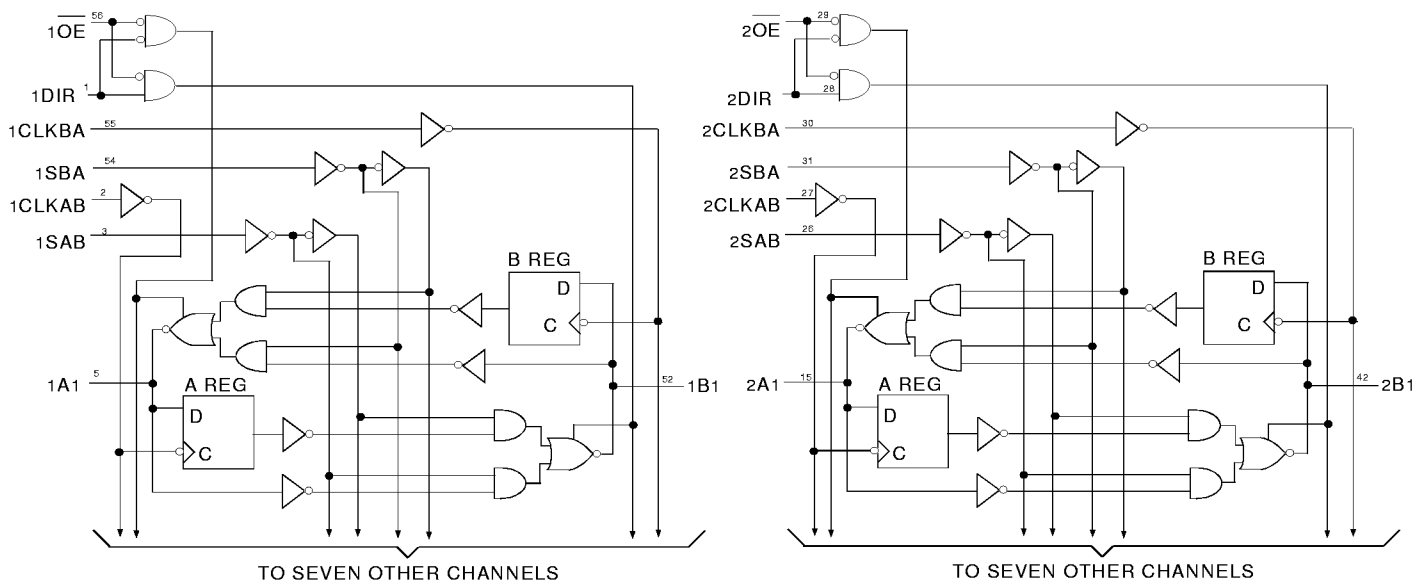
The LVCHR16646A 16-bit transceiver/register is built using advanced dual metal CMOS technology. This high-speed, low power device is organized as two independent 8-bit D-type transceivers with 3-state D-type registers. The controls circuitry is organized for multiplexed transmission of data between A bus and B bus either directly or from the internal storage registers. Each 8-bit transceiver/register features direction control (DIR), over-riding Output Enable control ( $\overline{OE}$ ) and Select lines (SAB and SBA) to select either real-time data or stored data. Separate clock inputs are provided for A and B port registers. Data on the A or B data bus, or both, can be stored in the internal registers by the low-to-high transitions at the appropriate clock pins. Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

All pins can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

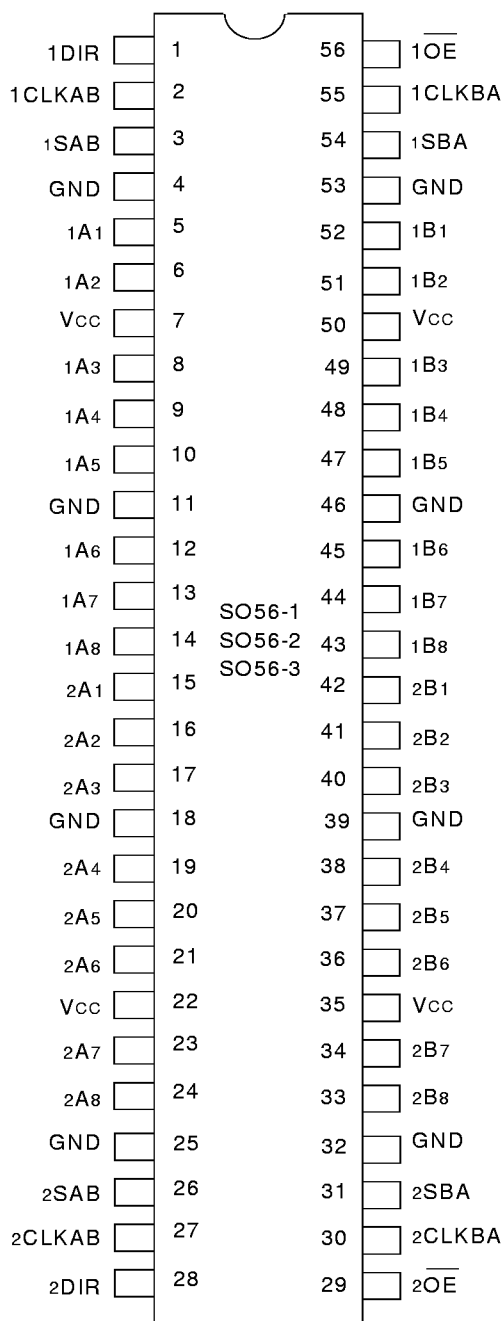
The LVCHR16646A has series resistors in the device output structure which will significantly reduce line noise when used with light loads. This driver has been developed to drive ±12mA at the designated threshold levels.

The LVCHR16646A has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors

## FUNCTIONAL BLOCK DIAGRAM



**PIN CONFIGURATION**



**SSOP/TSSOP/TVSOP**  
**TOP VIEW**

**ABSOLUTE MAXIMUM RATINGS (1)**

Symbol	Description	Max.	Unit
VTERM <sup>(2)</sup>	Terminal Voltage with Respect to GND	-0.5 to +6.5	V
VTERM <sup>(3)</sup>	Terminal Voltage with Respect to GND	-0.5 to +6.5	V
TSTG	Storage Temperature	-65 to +150	°C
I <sub>OUT</sub>	DC Output Current	-50 to +50	mA
I <sub>IK</sub> I <sub>OK</sub>	Continuous Clamp Current, V <sub>I</sub> < 0 or V <sub>O</sub> < 0	-50	mA
I <sub>CC</sub> I <sub>SS</sub>	Continuous Current through each V <sub>CC</sub> or GND	±100	mA

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**NOTES:**

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V<sub>CC</sub> terminals.
3. All terminals except V<sub>CC</sub>.

**CAPACITANCE (T<sub>A</sub> = +25°C, f = 1.0MHz)**

Symbol	Parameter <sup>(1)</sup>	Conditions	Typ.	Max.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 0V	4.5	6	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	6.5	8	pF
C <sub>I/O</sub>	I/O Port Capacitance	V <sub>IN</sub> = 0V	6.5	8	pF

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**NOTE:**

1. As applicable to the device type.

**PIN DESCRIPTION**

Pin Names	Description
xAx	Data Register A Inputs <sup>(1)</sup> Data Register B Outputs
xBx	Data Register B Inputs <sup>(1)</sup> Data Register A Outputs
xCLKAB, xCLKBA	Clock Pulse Inputs
xSAB, xSBA	Output Data Source Select Inputs
x $\overline{OE}$	Output Enable Inputs (Active LOW)
xDIR	Direction Control Inputs

**NOTE:**

1. These pins have "Bus-hold". All other pins are standard inputs, outputs, or I/Os.

## FUNCTION TABLE (1)

Inputs						Data I/O <sup>(2)</sup>		Operation or Function
x $\overline{OE}$	xDIR	xCLKAB	xCLKBA	xSAB	xSBA	xAx	xBx	
X	X	↑	X	X	X	Input	Unspecified	Store A, B unspecified <sup>(2)</sup>
X	X	X	↑	X	X	Unspecified	Input	Store B, A unspecified <sup>(2)</sup>
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input	Input	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time data to B bus
L	H	H or L	X	H	X	Input	Output	Stored A data to bus

### NOTES:

- H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Don't Care  
↑ = LOW-to-HIGH Transition
- The data-output functions may be enabled or disabled by various signals at  $\overline{OE}$  or DIR. Data-input functions always are enabled, i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

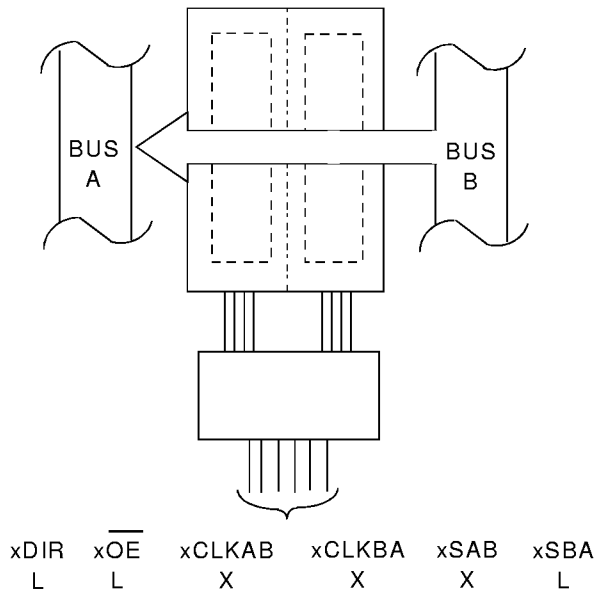
Operating Condition:  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

Symbol	Parameter	Test Conditions		Min.	Typ. <sup>(1)</sup>	Max.	Unit
$V_{IH}$	Input HIGH Voltage Level	$V_{CC} = 2.3\text{V}$ to $2.7\text{V}$		1.7	—	—	V
		$V_{CC} = 2.7\text{V}$ to $3.6\text{V}$		2	—	—	
$V_{IL}$	Input LOW Voltage Level	$V_{CC} = 2.3\text{V}$ to $2.7\text{V}$		—	—	0.7	V
		$V_{CC} = 2.7\text{V}$ to $3.6\text{V}$		—	—	0.8	
$I_{IH}$ $I_{IL}$	Input Leakage Current	$V_{CC} = 3.6\text{V}$	$V_I = 0$ to $5.5\text{V}$	—	—	$\pm 5$	$\mu\text{A}$
$I_{OZH}$ $I_{OZL}$	High Impedance Output Current (3-State Output pins)	$V_{CC} = 3.6\text{V}$	$V_O = 0$ to $5.5\text{V}$	—	—	$\pm 10$	$\mu\text{A}$
$I_{OFF}$	Input/Output Power Off Leakage	$V_{CC} = 0\text{V}$ , $V_{IN}$ or $V_O \leq 5.5\text{V}$		—	—	$\pm 50$	$\mu\text{A}$
$V_{IK}$	Clamp Diode Voltage	$V_{CC} = 2.3\text{V}$ , $I_{IN} = -18\text{mA}$		—	-0.7	-1.2	V
$V_H$	Input Hysteresis	$V_{CC} = 3.3\text{V}$		—	100	—	mV
$I_{CCL}$ $I_{CCH}$ $I_{CCZ}$	Quiescent Power Supply Current	$V_{CC} = 3.6\text{V}$	$V_{IN} = \text{GND}$ or $V_{CC}$	—	—	10	$\mu\text{A}$
			$3.6 \leq V_{IN} \leq 5.5\text{V}^{(2)}$	—	—	10	
$\Delta I_{CC}$	Quiescent Power Supply Current Variation	One input at $V_{CC} - 0.6\text{V}$ other inputs at $V_{CC}$ or GND		—	—	500	$\mu\text{A}$

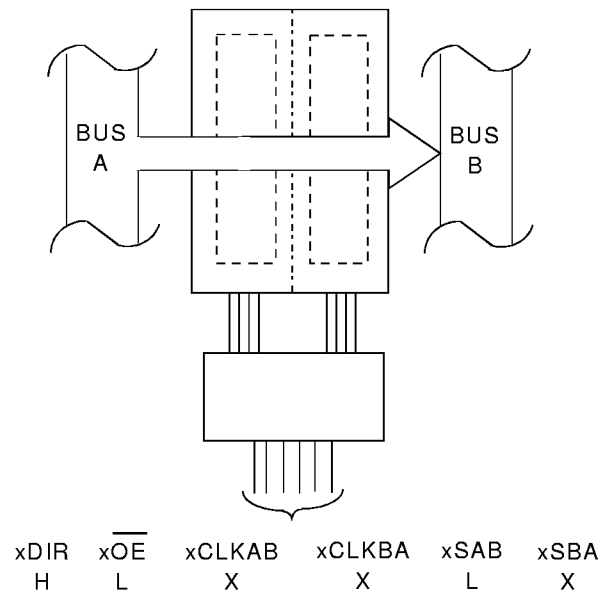
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### NOTES:

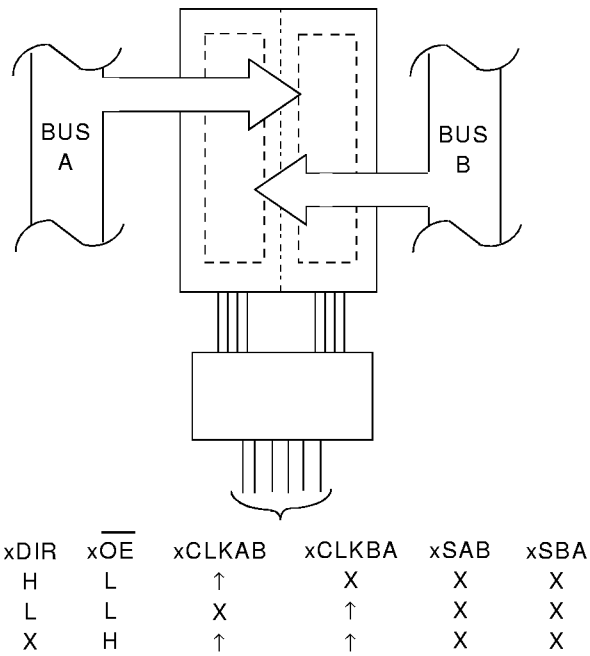
- Typical values are at  $V_{CC} = 3.3\text{V}$ ,  $+25^{\circ}\text{C}$  ambient.
- This applies in the disabled state only.



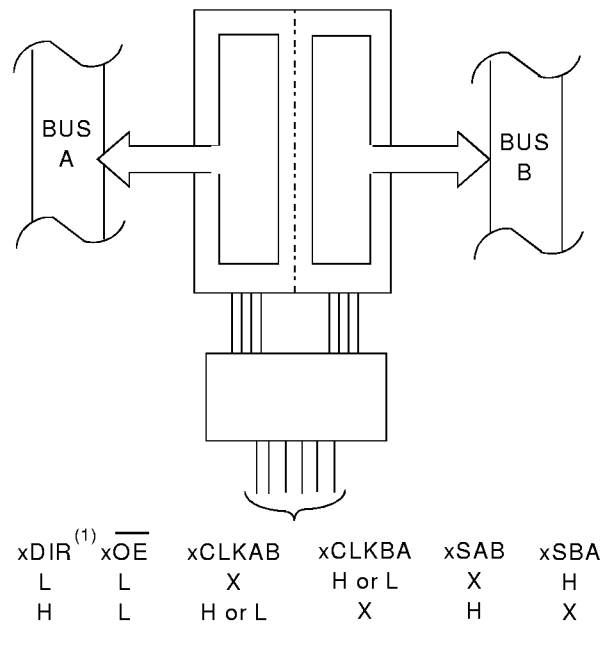
**REAL-TIME TRANSFER  
 BUS B TO A**



**REAL-TIME TRANSFER  
 BUS A TO B**



**STORAGE FROM  
 A, B, OR A AND B**



**TRANSFER STORED  
 DATA TO A AND/OR B**

**NOTE:**

1. Cannot transfer data to A Bus and B Bus simultaneously.

## BUS-HOLD CHARACTERISTICS

Symbol	Parameter <sup>(1)</sup>	Test Conditions		Min.	Typ. <sup>(2)</sup>	Max.	Unit
IBHH IBHL	Bus-Hold Input Sustain Current	V <sub>CC</sub> = 3.0V	V <sub>I</sub> = 2.0V	-75	—	—	μA
			V <sub>I</sub> = 0.8V	75	—	—	
IBHH IBHL	Bus-Hold Input Sustain Current	V <sub>CC</sub> = 2.3V	V <sub>I</sub> = 1.7V	—	—	—	μA
			V <sub>I</sub> = 0.7V	—	—	—	
IBHHO IBHLO	Bus-Hold Input Overdrive Current	V <sub>CC</sub> = 3.6V	V <sub>I</sub> = 0 to 3.6V	—	—	± 500	μA

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### NOTES:

1. Pins with Bus-hold are identified in the pin description.
2. Typical values are at V<sub>CC</sub> = 3.3V, +25°C ambient.

## OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions <sup>(1)</sup>		Min.	Max.	Unit
VOH	Output HIGH Voltage	V <sub>CC</sub> = 2.3V to 3.6V	IOH = -0.1mA	V <sub>CC</sub> - 0.2	—	V
			V <sub>CC</sub> = 2.3V	IOH = -4mA	1.9	
		IOH = -6mA		1.7	—	
		V <sub>CC</sub> = 2.7V	IOH = -4mA	2.2	—	
			IOH = -8mA	2	—	
		V <sub>CC</sub> = 3.0V	IOH = -6mA	2.4	—	
IOH = -12mA	2		—			
VOL	Output LOW Voltage	V <sub>CC</sub> = 2.3V to 3.6V	IOL = 0.1mA	—	0.2	V
			V <sub>CC</sub> = 2.3V	IOL = 4mA	—	
		IOL = 6mA		—	0.55	
		V <sub>CC</sub> = 2.7V	IOL = 4mA	—	0.4	
			IOL = 8mA	—	0.6	
		V <sub>CC</sub> = 3.0V	IOL = 6mA	—	0.55	
IOL = 12mA	—		0.8			

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### NOTE:

1. V<sub>IH</sub> and V<sub>IL</sub> must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate V<sub>CC</sub> range. T<sub>A</sub> = -40°C to +85°C.

## OPERATING CHARACTERISTICS, V<sub>CC</sub> = 3.3V ± 0.3V, T<sub>A</sub> = 25°C

Symbol	Parameter	Test Conditions	Typical	Unit
CPD	Power Dissipation Capacitance per transceiver Outputs enabled	C <sub>L</sub> = 0pF, f = 10Mhz	—	pF
CPD	Power Dissipation Capacitance per transceiver Outputs disabled		—	pF

## SWITCHING CHARACTERISTICS (1)

Symbol	Parameter	V <sub>CC</sub> = 2.7V		V <sub>CC</sub> = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay xAx to xBx or xBx to xAx	2	6.3	2	5.3	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay CLK to xAx or xBx	2	7.3	2	6.3	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay xSBA or xSAB to xAx or xBx	2	7.3	2	6.3	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable Time x $\overline{OE}$ to xAx or xBx	2	8.5	2	7.5	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable Time xDIR to xAx or xBx	2	8.5	2	7.5	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable Time x $\overline{OE}$ to xAx or xBx	2	7	2	6	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable Time xDIR to xAx or xBx	2	7	2	6	ns
t <sub>SU</sub>	Set-up Time HIGH or LOW Before CLKAB $\uparrow$ or CLKBA $\uparrow$	2.5	—	2.5	—	ns
t <sub>H</sub>	Hold Time HIGH or LOW After CLKAB $\uparrow$ or CLKBA $\uparrow$	1.5	—	1.5	—	ns
t <sub>W</sub>	Clock Pulse Width HIGH or LOW	3	—	3	—	ns
t <sub>SK(o)</sub>	Output Skew <sup>(2)</sup>	—	—	—	500	ps

### NOTES:

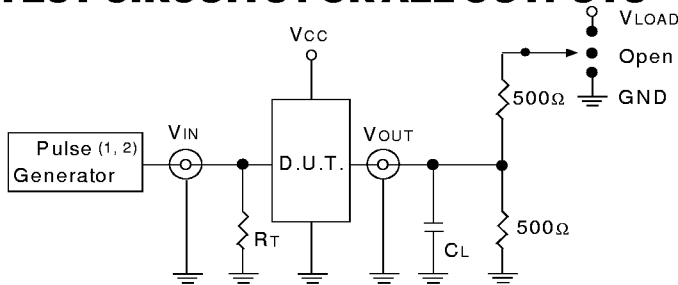
1. See test circuits and waveforms. T<sub>A</sub> = - 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

## TEST CIRCUITS AND WAVEFORMS

### TEST CONDITIONS

Symbol	Vcc(1) = 3.3V ±0.3V	Vcc(1) = 2.7V	Vcc(2) = 2.5V ±0.2V	Unit
V <sub>LOAD</sub>	6	6	2 x V <sub>cc</sub>	V
V <sub>IH</sub>	2.7	2.7	V <sub>cc</sub>	V
V <sub>T</sub>	1.5	1.5	V <sub>cc</sub> / 2	V
V <sub>LZ</sub>	300	300	150	mV
V <sub>HZ</sub>	300	300	150	mV
C <sub>L</sub>	50	50	30	pF

### TEST CIRCUITS FOR ALL OUTPUTS



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#### DEFINITIONS:

C<sub>L</sub> = Load capacitance: includes jig and probe capacitance.  
R<sub>T</sub> = Termination resistance: should be equal to Z<sub>OUT</sub> of the Pulse Generator.

#### NOTES:

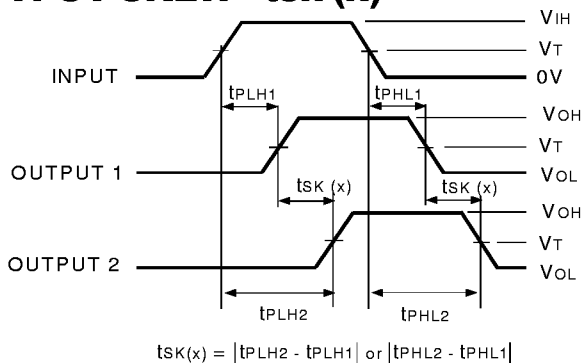
1. Pulse Generator for All Pulses: Rate ≤ 10MHz; t<sub>F</sub> ≤ 2.5ns; t<sub>R</sub> ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 10MHz; t<sub>F</sub> ≤ 2ns; t<sub>R</sub> ≤ 2ns.

### SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	V <sub>LOAD</sub>
Disable High Enable High	GND
All Other tests	Open

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### OUTPUT SKEW - t<sub>SK</sub>(x)

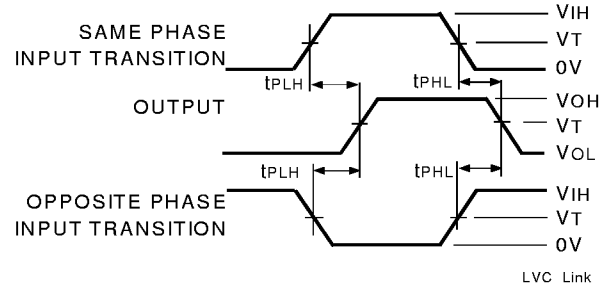


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#### NOTES:

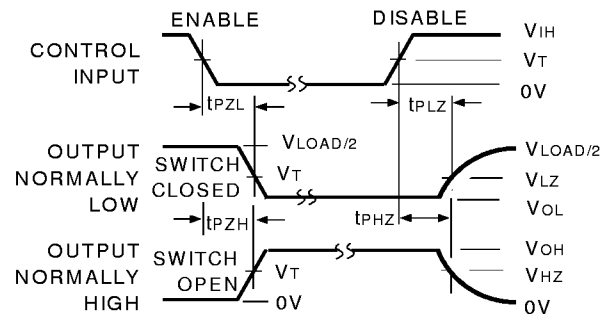
1. For t<sub>SK</sub>(a) OUTPUT1 and OUTPUT2 are any two outputs.
2. For t<sub>SK</sub>(b) OUTPUT1 and OUTPUT2 are in the same bank.

### PROPAGATION DELAY



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### ENABLE AND DISABLE TIMES

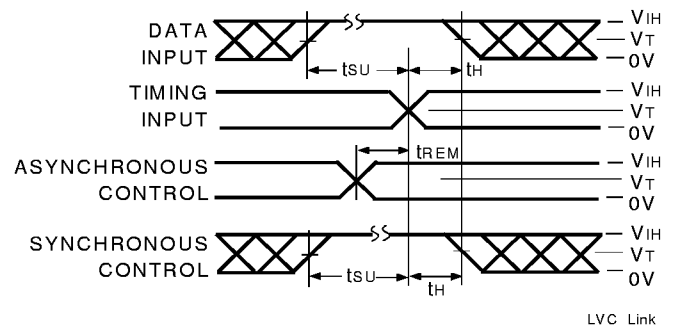


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#### NOTE:

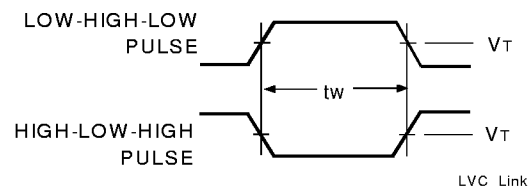
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

### SET-UP, HOLD, AND RELEASE TIMES



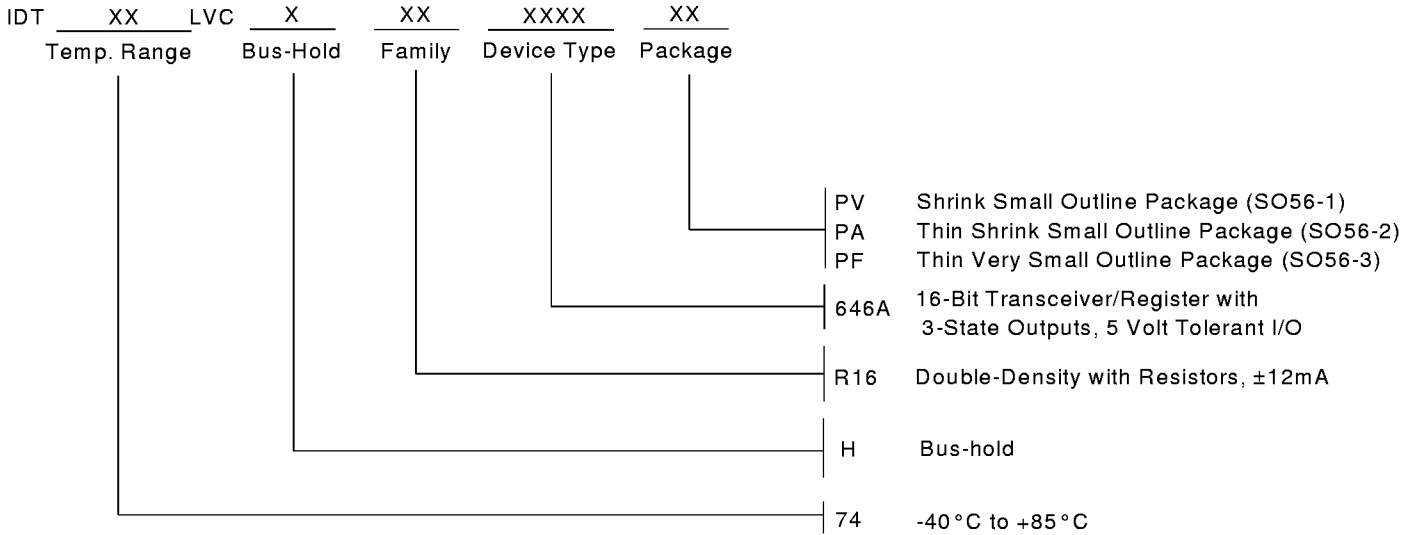
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### PULSE WIDTH



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